

PDFN3030 Plastic-Encapsulate MOSFETS

Features

- $V_{DS}=30V$
- $I_D=60A$
- $R_{DS(on)}@V_{GS}=10V < 6.5m\Omega$
- $R_{DS(on)}@V_{GS}=4.5V < 8m\Omega$
- Trench Power LV MOSFET technology
- Voltage controlled small signal switch
- Fast Switching Speedze

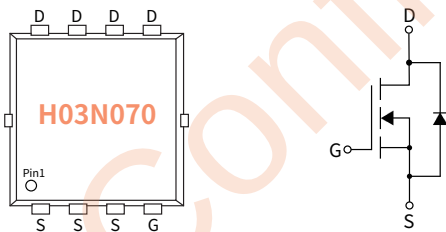
Applications

- DC-DC Converters
- Load switch
- Power management

Mechanical Data

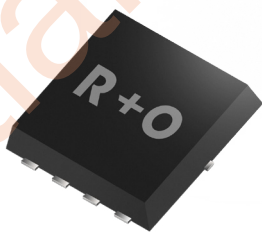
- Case: PDFN3030
Molding compound meets UL 94V-0 flammability rating, RoHS-compliant,halogen-free
- Terminals: Solder plated, solderable per MIL-STD-750,Method 2026

Function Diagram



Drain-source Voltage
30 V
Drain Current
60 Ampere

PDFN3030



Ordering Information

PACKAGE	PACKAGE CODE	UNIT WEIGHT(g)	REEL(pcs)	BOX(pcs)	CARTON(pcs)	DELIVERY MODE
PDFN3030	R3	0.0218	5000	10000	80000	13"

Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	VALUE
Drain-source Voltage	V_{DS}	V	30
Gate-source Voltage	V_{GS}	V	± 20
Drain Current	I_D	A	60
Pulsed Drain Current ⁽¹⁾	I_{DM}	A	240
Total Power Dissipation	P_D	W	40
Single pulse avalanche energy ⁽²⁾	EAS	mJ	110
Junction temperature	T_J	°C	-55 ~+150
Storage temperature	T_{stg}	°C	-55 ~+150
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	°C / W	3.1

● Static Parameter Characteristics (Tj=25°C Unless otherwise specified)

PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D =250μA	V	30	—	—
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V, V _{GS} =0V	μA	—	—	1.0
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} =0V	nA	—	—	±100
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D =250μA	V	1.0	1.5	2.5
Static Drain-Source On-Resistance ⁽³⁾	R _{DS(ON)}	V _{GS} = 10V, I _D =20A	mΩ	—	3.5	6.5
		V _{GS} = 4.5V, I _D =15A		—	6	8

● Dynamic Parameters

PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Input Capacitance	C _{iss}	V _{DS} =15V, V _{GS} =0V, f=1MHZ	pF	—	2655	—
Output Capacitance	C _{oss}			—	250	—
Reverse Transfer Capacitance	C _{rss}			—	230	—

● Switching Parameters

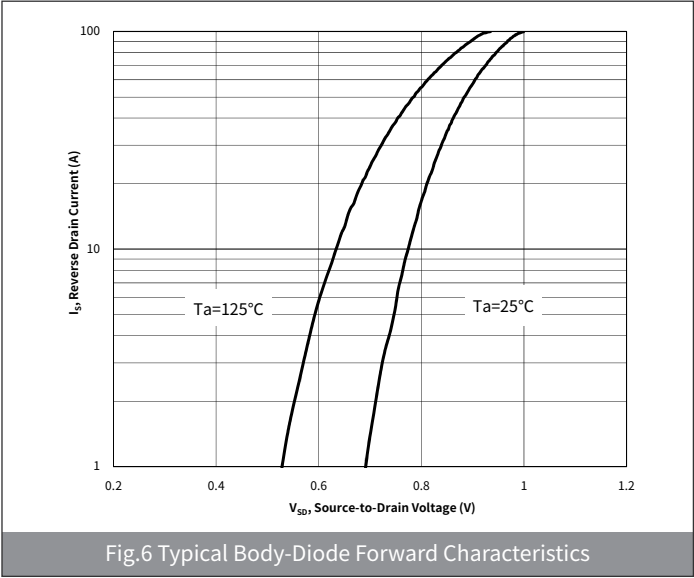
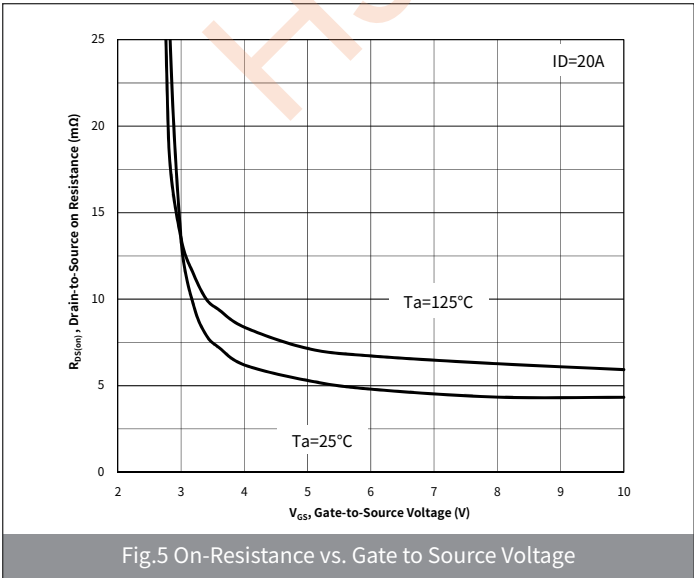
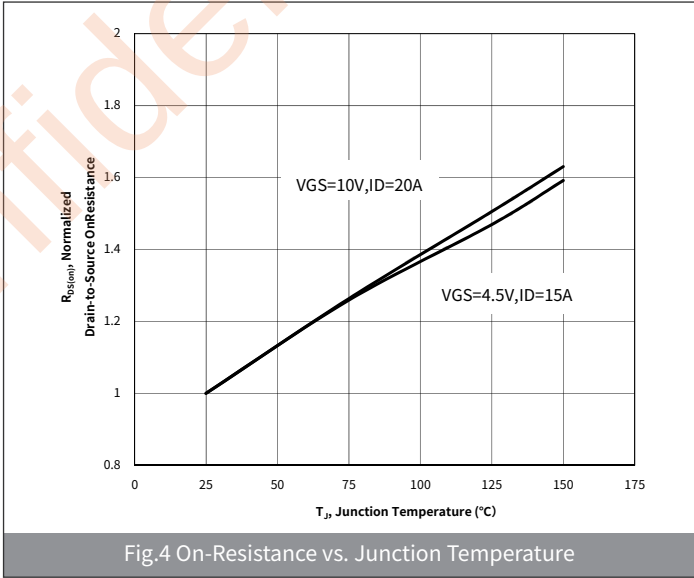
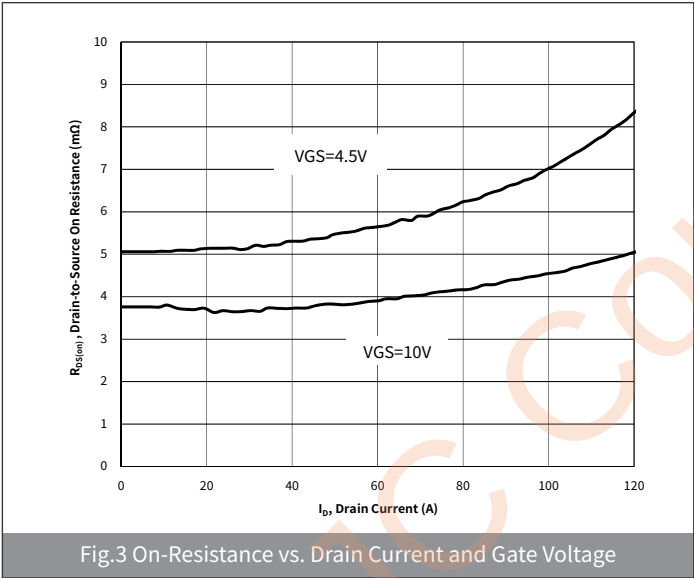
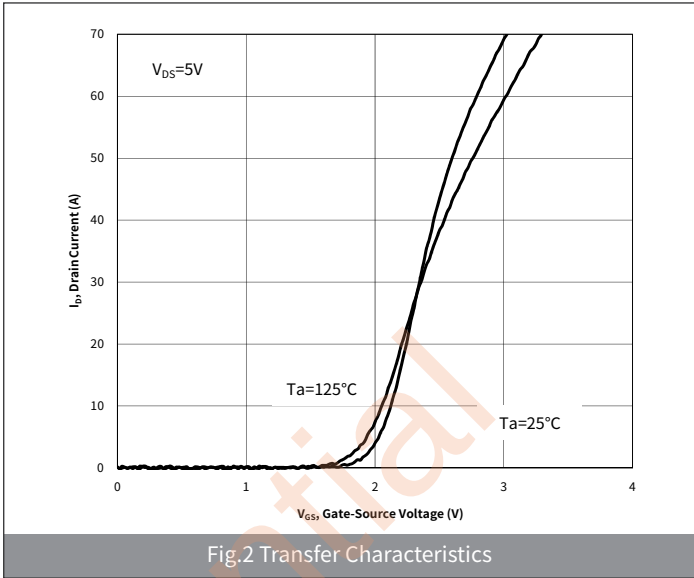
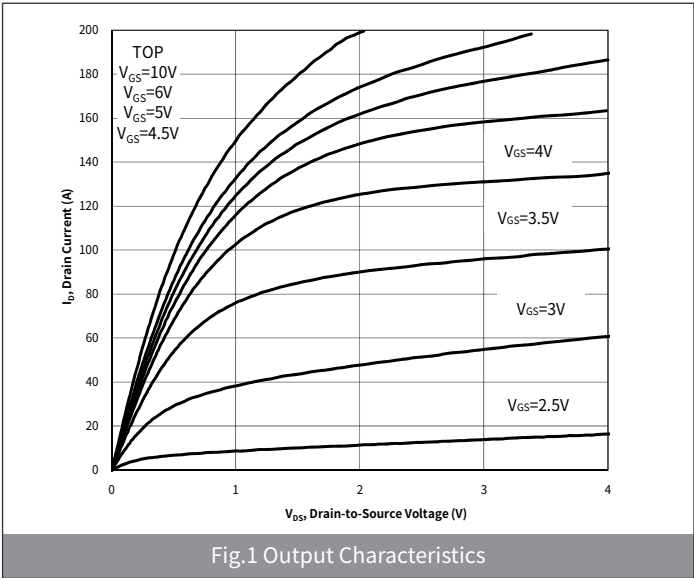
PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Turn-on Delay Time	t _{D(on)}	V _{GS} =10V, V _{DD} =15V, I _D =20A ,R _{GEN} =3Ω	nS	—	12	—
Turn-on Rise Time	t _r		nS	—	15	—
Turn-off Delay Time	t _{D(off)}		nS	—	40	—
Turn-off fall Time	t _f		nS	—	14	—
Total Gate Charge	Q _g	V _{DS} =15V, I _D =30A V _{GS} =10V	nC	—	60	—
Gate-Source Charge	Q _{gs}		nC	—	8.2	—
Gate-Drain Charge	Q _{gd}		nC	—	7.4	—

● Drian-Source Diode Characteristics

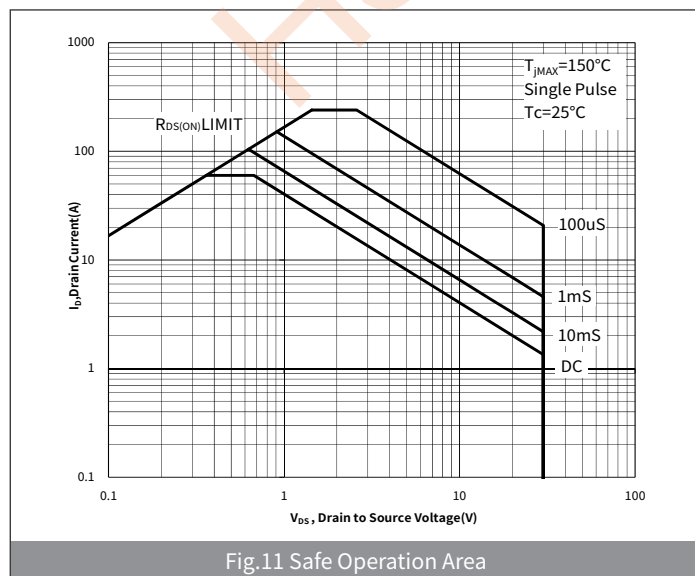
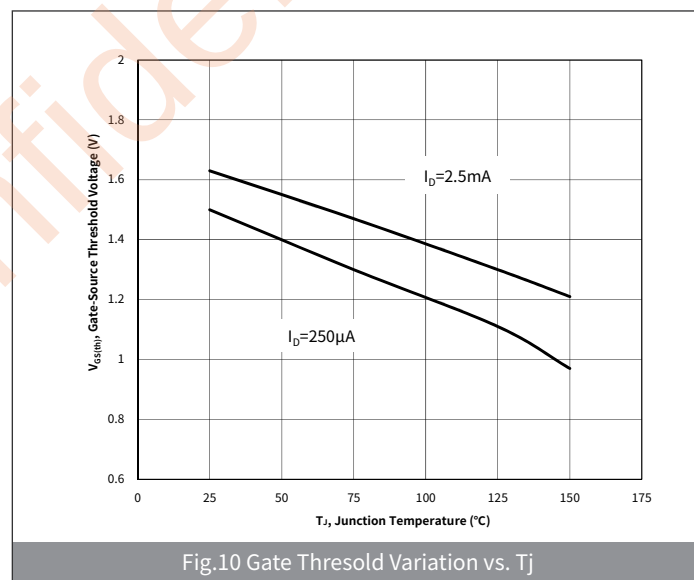
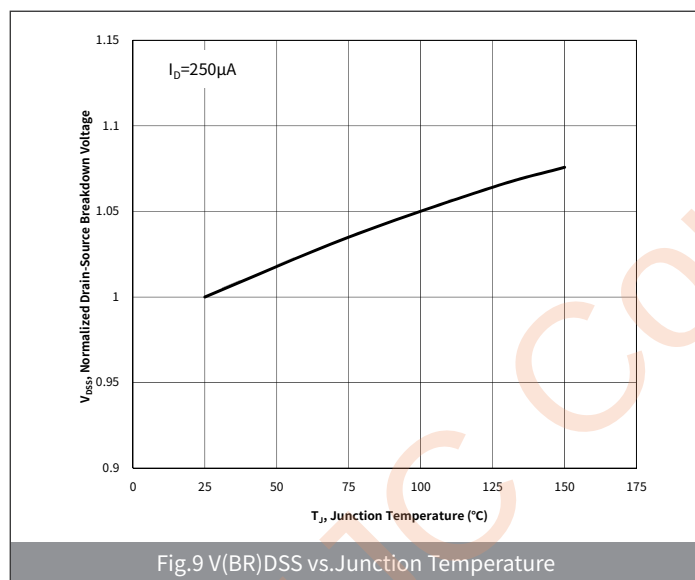
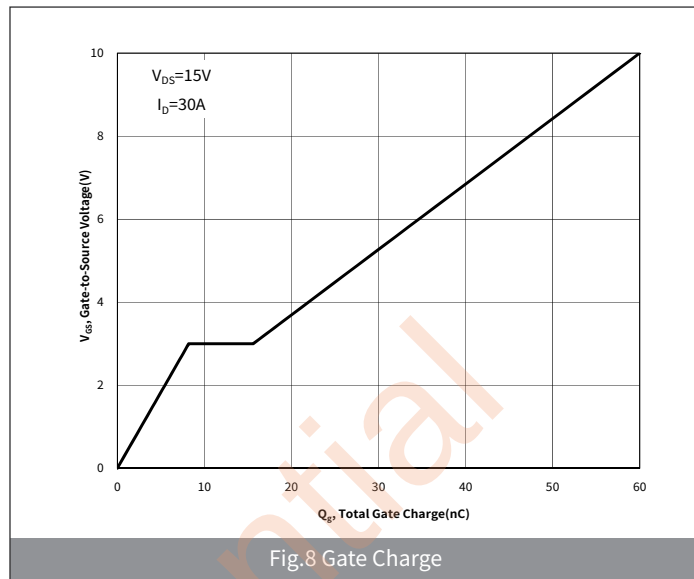
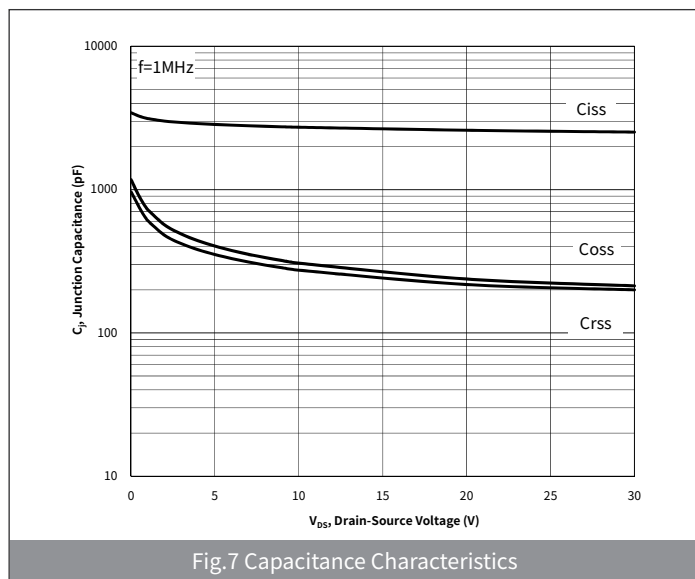
PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Diode Forward Voltage	V _{SD}	I _S =1A, V _{GS} =0V	V	—	—	1.2
Maximum Body-Diode Continuous Current	I _S	—	A	—	—	60
Reverse recover time	T _{rr}	I _S =20A, di/dt=100A/us, Tj=25°C	nS	—	47	—
Reverse recovery charge	Q _{rr}		nC	—	45	—

Note :
(1)Repetitive Rating: Pulse width limited by maximum junction temperature.
(2)EAS condition : Tj=25°C ,VDD=15V,VG=10V,L=0.5mH,IAS=21A,Rg=25Ω.
(3)Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.

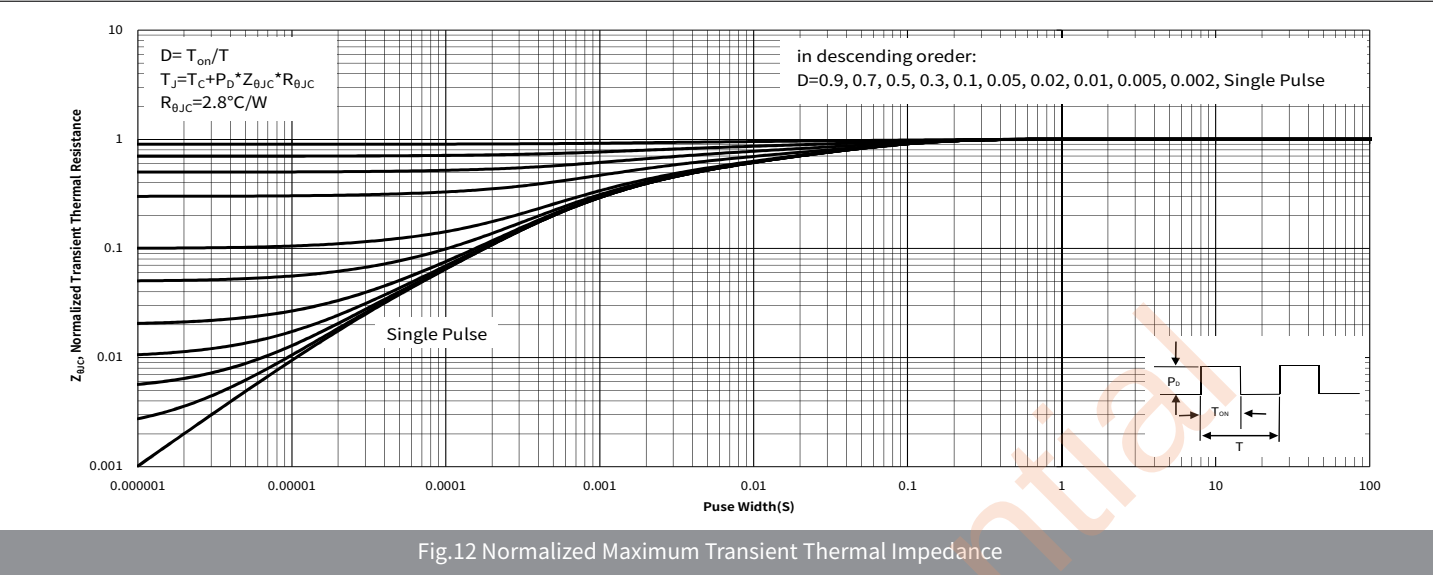
● Ratings And Characteristics Curves (Ta=25°C Unless otherwise specified)



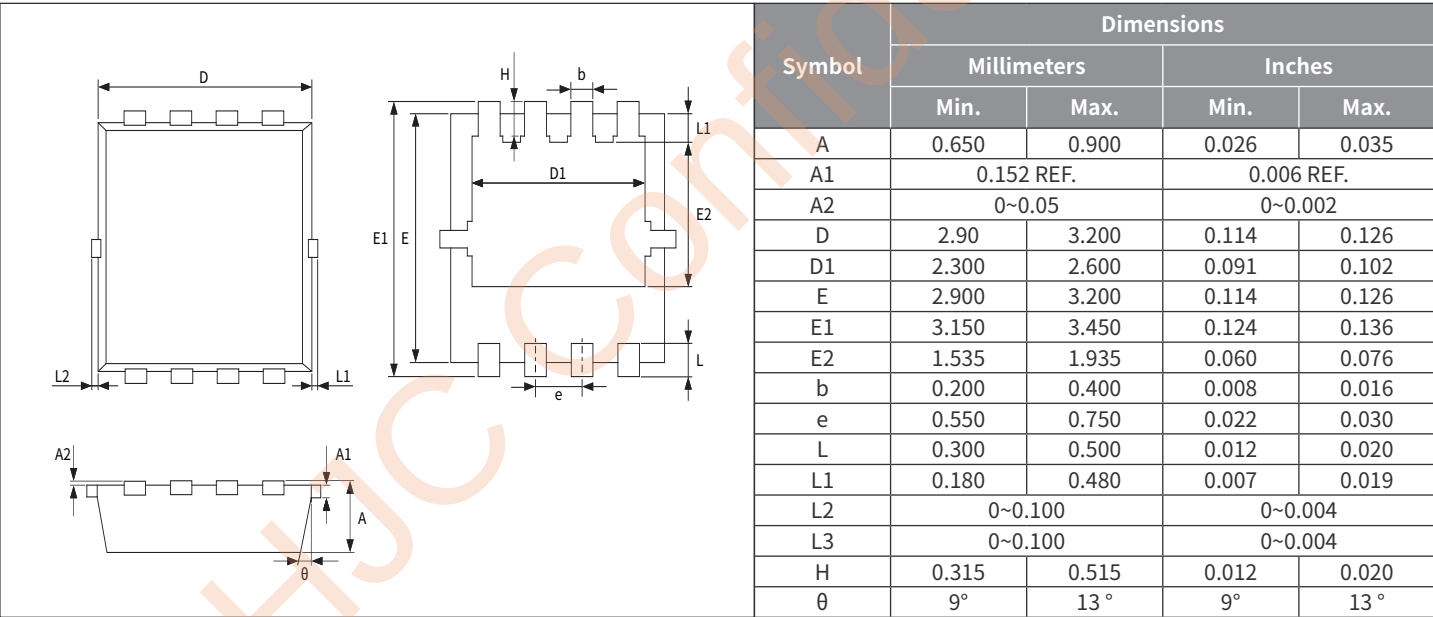
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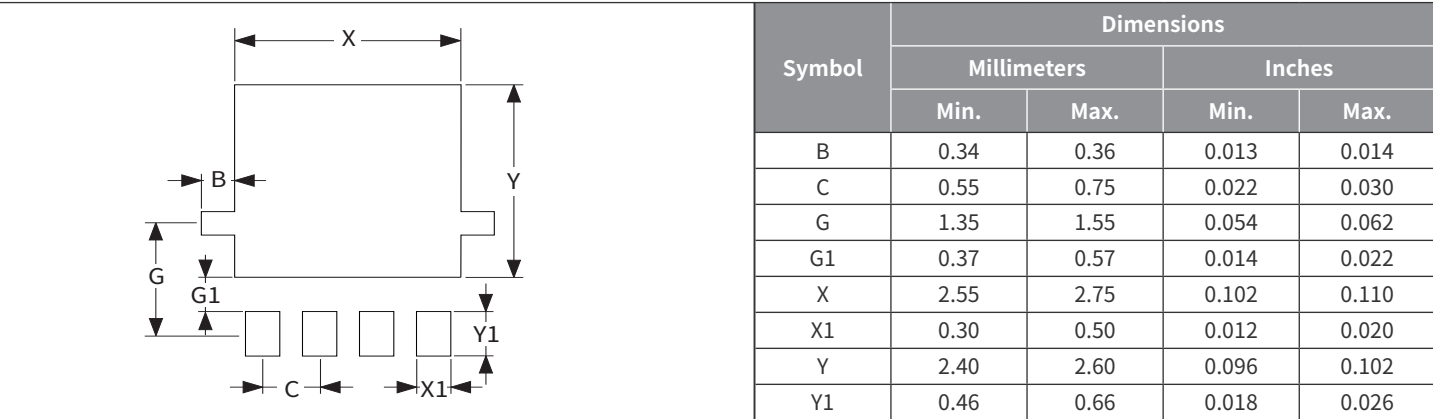
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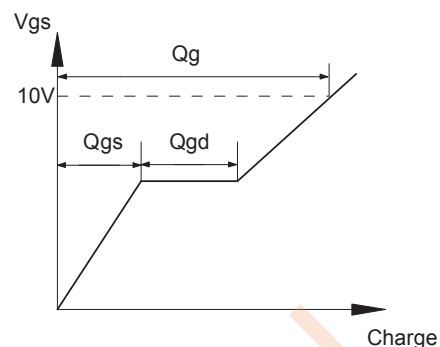
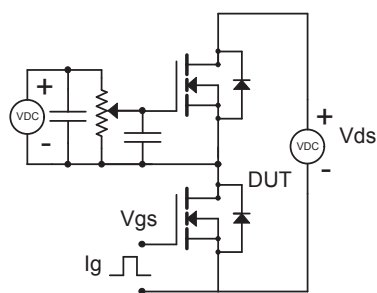
● Package Outline Dimensions (PDFN3030)



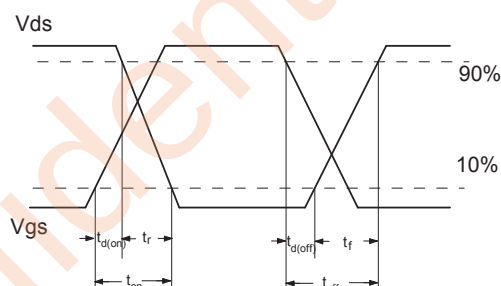
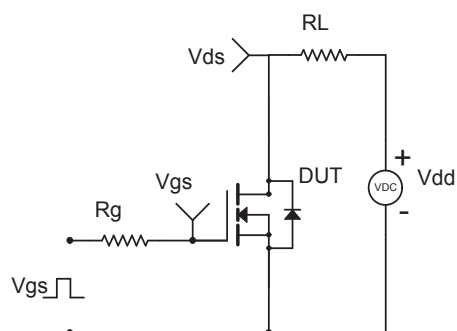
● Suggested Pad Layout



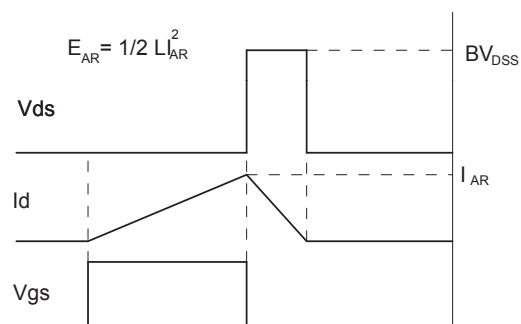
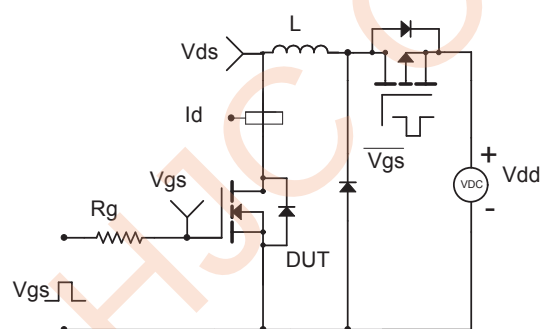
1. Gate Charge Test Circuit & Waveforms



2. Resistive Switching Test Circuit & Waveforms



3. Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



4. Diode Recovery Test Circuit & Waveforms

